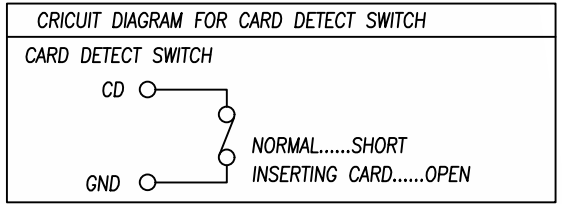


REV.	DESCRIPTION	ECN NO.	NAME	DATE

- NOTES:
- MATERIAL:**  
 HOUSING: High Temperature Thermoplastic  
 Terminal: Copper Alloy  
 Shell: Stainless Steel
  - PLATING:**  
 Terminal: 50u" Ni UNDERPLATED OVERALL  
 G/F PLATED ON CONTACT AREA AND SOLDER AREA  
 Shell: 30u" Ni UNDERPLATED OVERALL  
 G/F PLATED ON CONTACT AREA AND SOLDER AREA
  - TECHNICAL SPECIALITY:**  
 RATED VOLTAGE: 30V AC MAX.  
 CURRENT RATING: 0.5A MAX.  
 INSULATION RESISTANCE: 1000MΩ MIN  
 CONTACT REISTANCE: 50mΩ MAX  
 WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES  
 OPERATING TEMPERATURE: -40 ~+85 Humidity 80% R.H MAX
  - DIMENSIONS WITH MARK \* "MUST BE MEASURE BY QC AND IPQC**

RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE: ±0.05)  
 RECOMMENDED MATAL MASK T=0.12mm

- SMT SOLDER AREA
- NO PATTERN AND VIA HOLE IN HTIS AREA

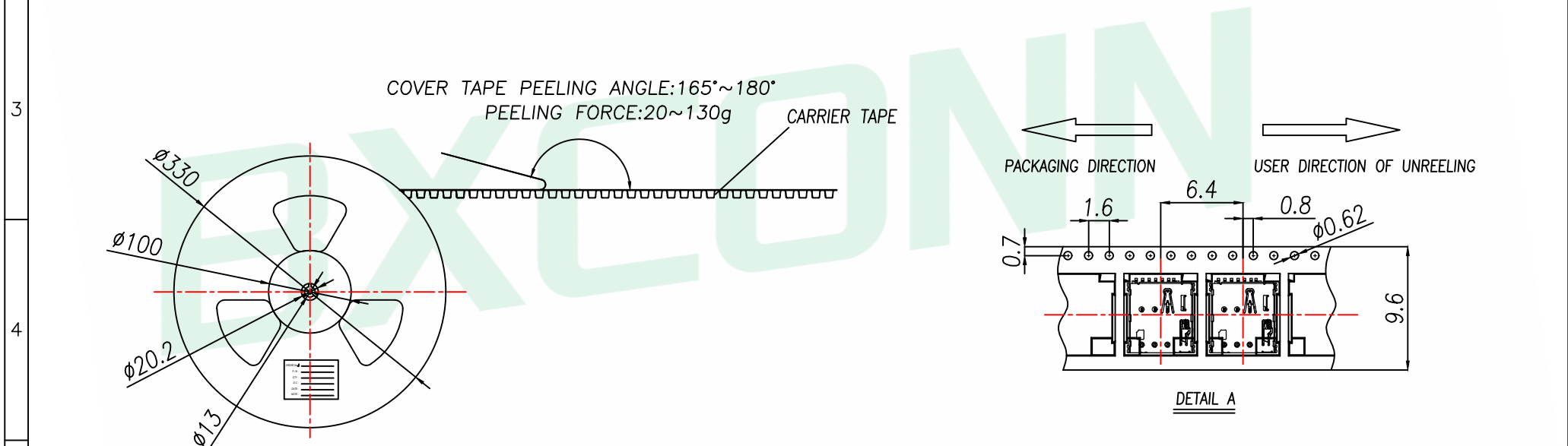
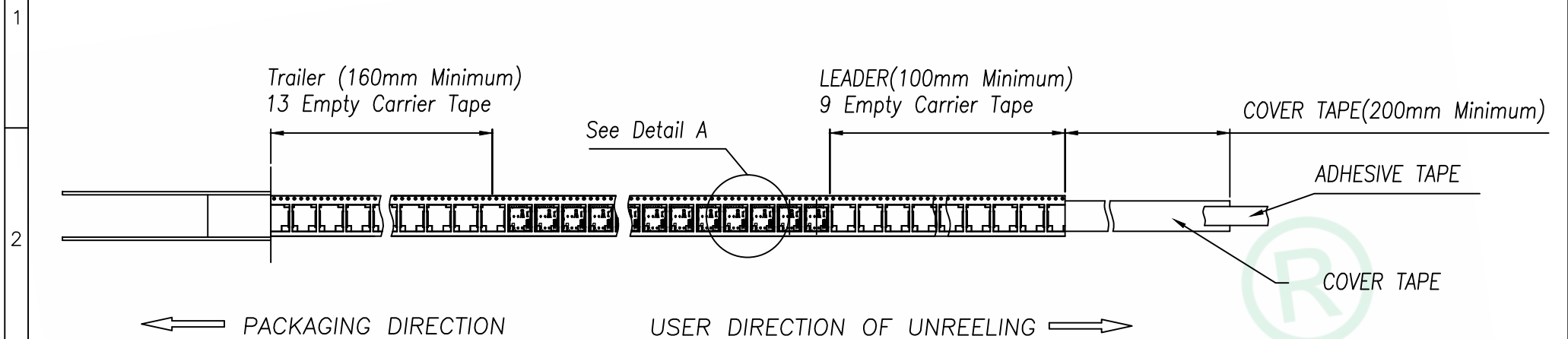


PIIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O


GENERAL TOLERANCE	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD			
DIM. x. x.x x.xx GENERAL ANGLE: x° x.x° x.xx°	TOL. ±0.35 ±0.15 ±0.10 ±2° ±1° ±0.5°	TITLE: NanoSIM卡座 自弹式 外壳不锈钢 端子铜	DWG. NO.: NANO-SIM-H137	
UNIT: mm		SCALE: none	SHEET: 1 of 1	DWG. SIZE: A4
LAYER: bxconn		CHECKED: MAX	DRAWN: ELLA	
APPROVED: WILL				

**BXCONN**<sup>®</sup>

A		B		C		D		E	
REV.	DESCRIPTION				ECN NO.	NAME	DATE		



1	NANO-7P-H137	1500	10		15000	350X350X340
ITEM	PRODUCT NO	QTY/REEL	REEL/CARTON	Kg/CARTON	QTY/CARTON	CARTON SIZE

GENERAL TOLERANCE		DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD				BXCONN <sup>®</sup>	
DIM.	TOL.	TITLE: NanoSIM卡座 自弹式 外壳不锈钢 端子铜					
x.	±0.35	DWG. NO.: NANO-SIM-H137		CHECKED: MAX			
x.x	±0.15	PART NO.: NANO-SIM-H137		DRAWN: ELLA			
x.xx	±0.10	UNIT: mm		SCALE: none	SHEET: 1 of 1		
GENERAL ANGLE:		LAYER: bxconn		APPROVED: WILL			
x.°	±2°						
x.x°	±1°						
x.xx°	±0.5°						